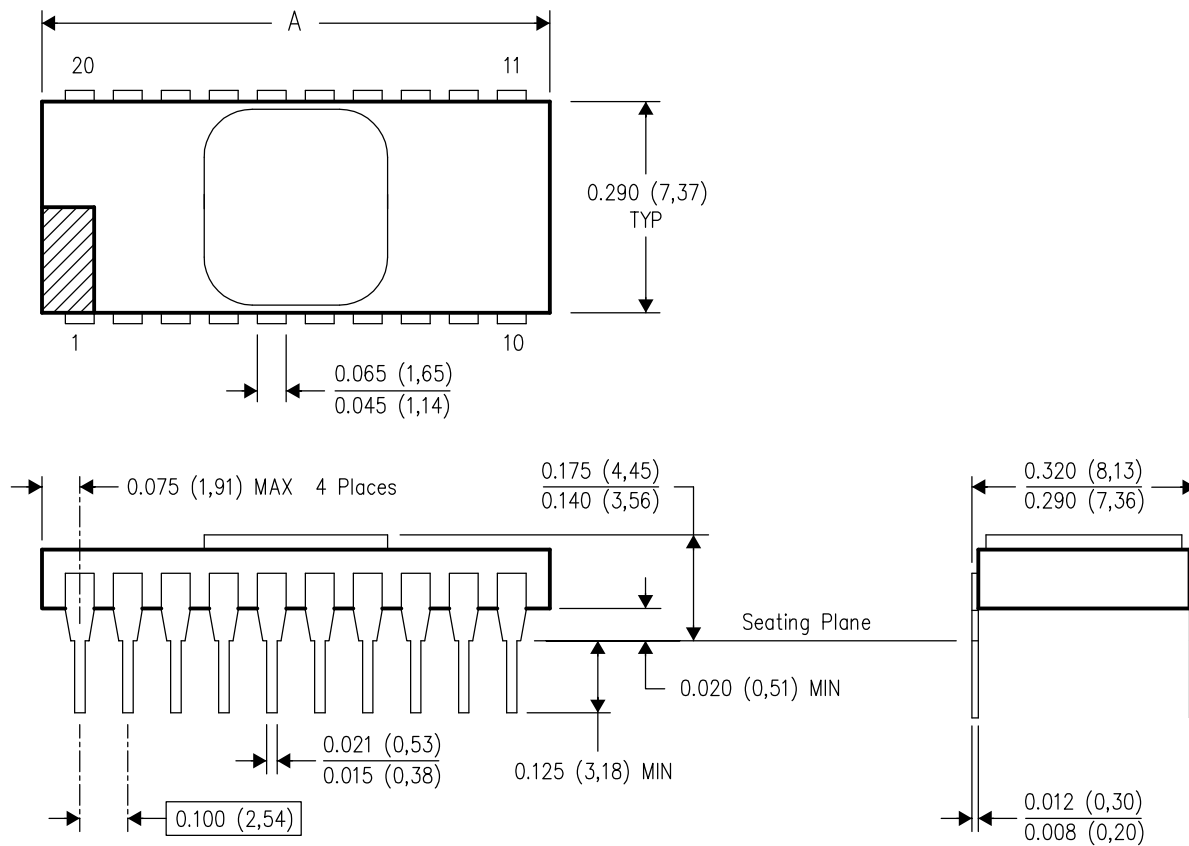


JD (R-CDIP-T**)

CERAMIC SIDE-BRAZE DUAL-IN-LINE PACKAGE

20 PINS SHOWN



PINS **	8	14	16	18	20	24
DIM						
A MAX	0.405 (10,29)	0.757 (19,23)	0.810 (20,57)	0.910 (23,11)	1.010 (25,65)	1.100 (27,94)

4040086-2/F 07/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a metal lid.
 - The terminals are gold plated.
 - Falls within MIL STD 1835 CDIP2 - T8, T14, T16, T18, T20 and T24 respectively.

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